

A71CL

Plug & Trust Secure Element for Alibaba Cloud

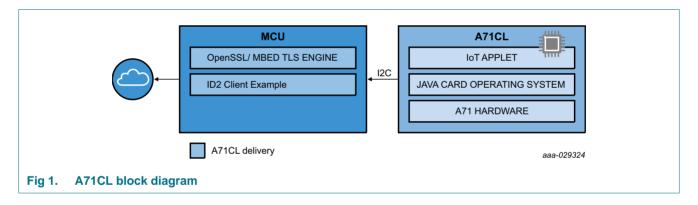
Rev. 3.0 — 28 November 2018 485030

Product short data sheet COMPANY PUBLIC

1. Introduction

The A71CL is a ready-to-use solution providing a root of trust at the IC level and proven, chip-to-cloud security right out of the box. The product configuration has the provisioned credential to support Alibaba Cloud. It is a platform capable of securely storing and provisioning credentials, securely connecting IoT devices to cloud services and performing cryptographic node authentication.

The A71CL solution provides security measures protecting the IC against physical and logical attacks. The solution is meant to be integrated with a host platform and running operating systems adding a chain of trust for a broad range of applications. The product is delivered with a manual and a set of documents to provide guidance on its integration within a complete system; offering easy design-in with plug & play host application code, development kits, reference designs.





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2. General description

2.1 A71CL naming conventions

The following table explains the naming conventions of the commercial product name of the A71CL products. Every A71CL product gets assigned such a commercial name, which includes also customer and application specific data.

The A71CL basic type names have the following format.

A71CLxagpp(p)

The 'A71CL' is a constant, all other letters are variables, which are explained in Table 1.

Table 1. A71CL commercial name format

Variable	Meaning	Values	Description
х	IC hardware specification code	1	standard operational ambient temperature: -25 °C to +85 °C I ² C interface supported
		2	standard operational ambient temperature: -40 °C to +90 °C I ² C interface supported
а	embedded operating system code	С	Java card operating system
g	embedded application firmware (applet) code	L	L is a fixed value = IoT security applet pre installed
pp(p)	package type code dd(d)= Delivery Type, TK2= HVSON8 (4x4)		

2.2 I²C interface

The A71CL has an I²C interface in slave mode, supporting data rates up to 400 kbit/s operating in Fast-Mode (FM). The I²C interface is using the Smartcard I²C protocol as defined in Ref. 3 which is based on SMBus.

Depending on the interface pins state at boot, see <u>Section 7 "Pinning information"</u> for more details; the default I²C address after power-on-reset is 0x90 for Write, and 0x91 for Read.

2.3 Security licensing

NXP Semiconductors has obtained a patent license for SPA and DPA countermeasures from Cryptography Research Incorporated (CRI). This license covers both hardware and software countermeasures. It is important to customers that countermeasures within the operation system are covered under this license agreement with CRI. Further details can be obtained on request.

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3. Features and benefits

3.1 Key benefits

- Secure, zero-touch connectivity
- End-to-end security, from chip to edge to cloud
- Secure credential injection for IC-level root of trust
- Fast design-in with complete product support package
- Easy to integrate with different MCU platforms

3.2 Security features

The A71CL security concepts includes many security measures to protect the chip.

The A71CL operates fully autonomously based on an integrated Javacard operating system and applet. Direct memory access is possible by the fixed functionalities of the applet only. With that, the content from the memory is fully isolated from the host system.

Attack protection by integrated design measures in the chip layout, the logic and the functional blocks.

3.3 Cryptography features

- Message digest with SHA1, SHA224, SHA256
- Random number generator
- Asymmetric key storage type: RSA Standard or RSA CRT
- Auto RSA key generator ranges from 512-bit key length to 2048-bit key length. Either RSA Standard or RSA CRT.
- Symmetric encryption/decryption with DES_CBC_NOPADDING,
 DES_ECB_NOPADDING, AES_CBC_NOPADDING, AES_ECB_NOPADDING.
- Symmetric signature/verification with DES_CBC_ISO9797_M1,
 DES CBC ISO9797 M2, AES CBC ISO9797 M1, AES CBC ISO9797 M2.
- Asymmetric encryption/decryption with RSA_NOPADDING, RSA_ PKCS1.
- Asymmetric signature/verification with RSA SHA1(PKCS1), RSA SHA256.
- Service data storage: the storage data read and write is protected by SCP.
- SCP 02 service with option "i" = '55'.

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3.4 Functional features

- 400 kbit/s I²C Fast-mode interface
- -40 °C to +90 °C operational ambient temperature (A7102)
- On-chip Javacard operating system
- 40 μA typical sleep mode current with I²C pads in tristate mode
- 10 μA max deep sleep mode current with I²C pads in tristate modeS
- High-performance Public Key Infrastructure (PKI)
- EEPROM with min 500,000 cycles endurance and min 25 years retention time
- HVSON8 package

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4. Applications

4.1 Use Cases and target applications

- A710xCL EXAMPLE USE CASES
 - Secure connection to public/private clouds, edge computing platforms, infrastructure
 - Secure commissioning
 - ◆ Device-to-device authentication
 - Proof of origin / anti-counterfeiting
 - Key storage and data protection
- A710xCL TARGET APPLICATIONS
 - Connected industrial devices
 - Sensor networks
 - ◆ IP cameras
 - Home gateways
 - Home appliances

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5. Ordering information

5.1 Ordering options

Table 2. Ordering information

Type number[1]	Package			
	Name	Description	Version	
A7101agTK2/	HVSON-8	plastic thermal enhanced very thin small outline package; no leads; 8	SOT909-1	
A7102agTK2/		terminals; body 4 × 4 × 0.85 mm		

^[1] a = A or C, g = G, C or A, according to the A71CL type classification see Section 2.1 "A71CL naming conventions"

Table 3 gives an overview of available A71CL product types.

Table 3. A71CL feature table

Orderable type	Product type number[1]		Operational ambient temperature	Commercial name
A7101CLTK2/T0BC2WJ	A7101CLTK2/T0BC2WE	935368739118		A71CL, provisioned
A7102CLTK2/T0BC2XJ	A7102CLTK2/T0BC2XR	935379152118	–40 °C to +90 °C	and ready to use for Alibaba Cloud

^[1] HN1, according the A71CL type classification see Section 2.1 "A71CL naming conventions"

5.1.1 Ordering A71CL samples

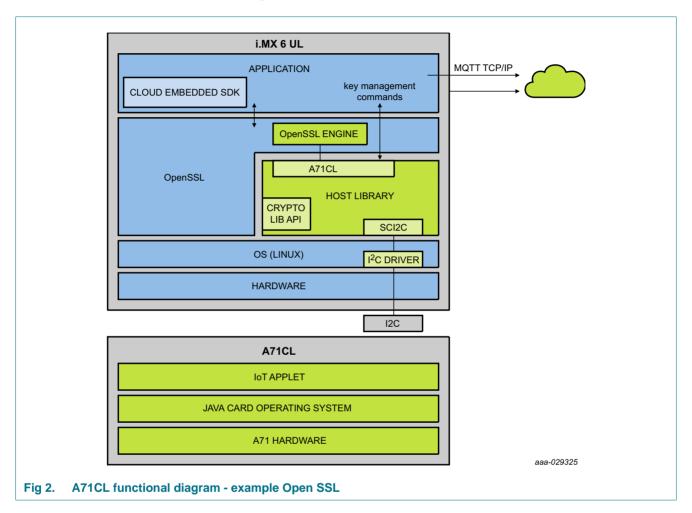
Samples can be ordered from the NXP Semiconductors e-commerce website.

Note that NXP Semiconductors can provide up to 5 pieces free of charge. Larger quantities have to be ordered separately.

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6. Functional description

6.1 Functional diagram



The A71CL uses I²C as communication interface as described in the following section. The A71CL commands are wrapped using the Smartcard I² protocol (SCI2C). The detailed documentation for the A71CL commands [ref to APDU Spec] and SCI2C encapsulation (Ref. 3) is available in NXP docstore."

In order to simplify the product usage a host library was created which takes care for the A71CL commands and SCI2C protocol encapsulation. The host library is available on the A71CL website. The APDU specification is available for download with complete sources on the A71CL website.

6.2 I²C Interface

The A71CL has an I^2C interface in slave mode, supporting data rates up to 400 kbit/s operating in Fast-Mode (FM). The I^2C interface is using the Smartcard I^2C protocol as defined in Ref. 3 which is based on SMBus. Depending on the interface pins state at boot, see Section 7 for more details. The default I^2C address after power-on-reset depends on the bootup condition as shown in Table 4.

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6.3 Automatic Communication Mode detection at Power on

The IC configures its interface according to the pin state as shown in the table below. The host system must keep the voltage levels stable at these pins for at least 500 μ s after power-on-reset.

Table 4. I²C address

Value at startup			I ² C ac	ldress	
IF0	IF1	I2C_SCL	I2C_SDA	Write	Read
0	х	0	0	n.a.	n.a.
1	0	1	1	0x90	0x91
1	1	1	1	0x92	0x93

6.4 Power-saving modes

The device provides two power-saving operation modes, the SLEEP mode and the DEEP SLEEP mode. These modes are activated via pad RST_N (DEEP SLEEP mode) or by the device.

6.4.1 SLEEP mode

The SLEEP mode has the following properties:

- all internal clocks are frozen,
- CPU enters power saving mode with program execution being stopped,
- CPU registers keep their contents,
- RAM keeps its contents,

The A71CL enters automatically into SLEEP mode and also wakes up automatically from SLEEP mode. In SLEEP mode, all internal clocks are stopped. The IOs hold the logical states they had at the time IDLE was activated. During SLEEP mode security sensors HVS, LVS, LTS, HTS, Light Sensors, Glitch Sensors and Active Shielding are disabled.

There are two ways to exit from the SLEEP mode:

- A reset signal on RST_N
- An External Interrupt edge triggered by a falling edge on I2C_SDA

6.4.2 DEEP SLEEP mode

The A71CLx provides a special sleep mode offering maximum power saving. It is reached by pulling RST_N to a logic zero level for more than 500 μ s.

While in deep sleep mode the internal power is completely switched off and only the IO pads stay supplied. All digital pads will stay in high-Z mode.

To leave the DEEP SLEEP mode RST N has to be released and set to a logic "1" level.

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7. Pinning information

7.1 Pinning

7.1.1 Pinning HVSON8

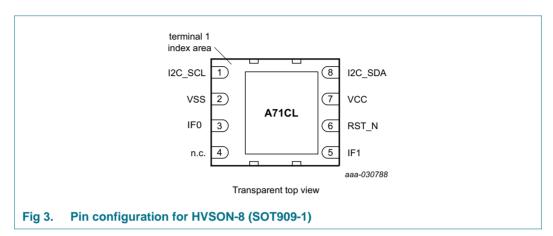


Table 5. Pin description HVSON8

Symbol	Pin	Description
I2C_SCL	1	I ² C clock
VSS	2	ground
IF0	3	interface activation, apply high on startup
n.c.	4	not connected
IF1	5	I ² C address selection
RST_N	6	reset input, active LOW
VCC	7	power supply voltage input
I2C_SDA	8	I ² C data

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8. Package outline

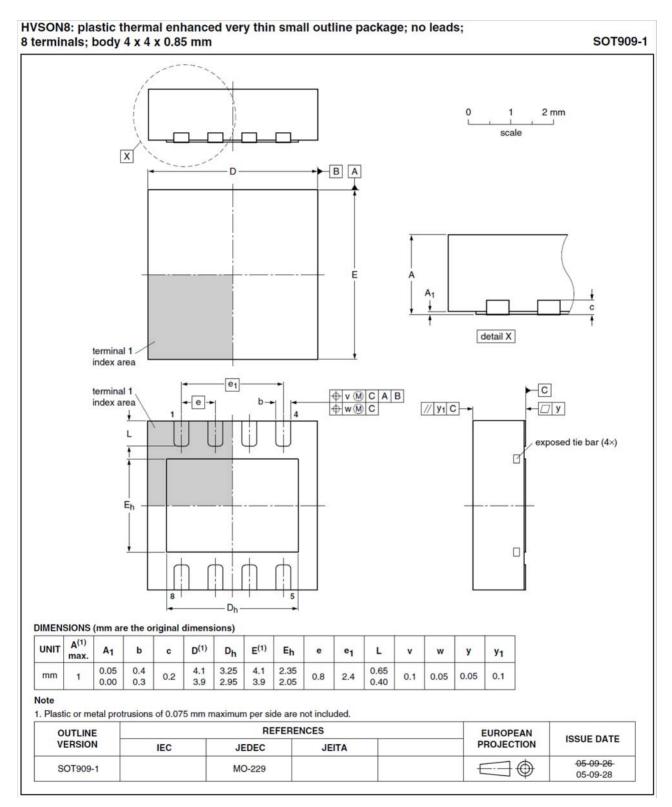


Fig 4. Package outline SOT909-1

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9. Packing information

9.1 Reel packing

The A71CL product is available on 7" tape on reel and 13" tape on reel. Details are provided in Table 6.

Table 6. Reel packing options

Package type	Reel type	Minimum packing quantity
HVSON8	7" tape on reel	1500
HVSON8	13" tape on reel[1]	6000

^[1] For details about packing method, product orientation, tape dimensions and labeling for A71 parts in HVSON8 package having an ordering code (12NC) ending 118 refer to Ref. 2.

10. Electrical and timing characteristics

The electrical interface characteristics of static (DC) and dynamic (AC) parameters for pads and functions used for I²C are in accordance with the NXP I²C specification (see Ref. 1).

11. Limiting values

Table 7. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to VSS (ground = 0 V).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DD}	supply voltage			-0.3	+4.6	V
VI	input voltage	any signal pad		-0.3	+4.6	V
I _I	input current	pad I2C_SDA, I2C_SCL		-	10	mA
I _O	output current	pad I2C_SDA, I2C_SCL		-	10	mA
I _{lu}	latch-up current	$V_I < 0 \text{ V or } V_I > V_{DD}$		-	100	mA
V _{esd_hbm}	electrostatic discharge voltage (Human Body Model)	pads VCC, VSS, RST_N, I2C_SDA, I2C_SCL	[1]		± 2.0	kV
V _{esd_cdm}	electrostatic discharge voltage (Charge Device Model)	pads VCC, VSS, RST_N, I2C_SDA, I2C_SCL	[3]		± 500	V
P _{tot}	Total power dissipation		[2]	-	1	W
T _{stg}	Storage temperature			-55	+125	°C

^[1] MIL Standard 883-D method 3015; human body model; C = 100 pF, R = 1.5 k Ω ; $T_{amb} = -25$ °C to +85 °C.

^[2] Depending on appropriate thermal resistance of the package.

^[3] JESD22-C101, JEDEC Standard Field induced charge device model test method.

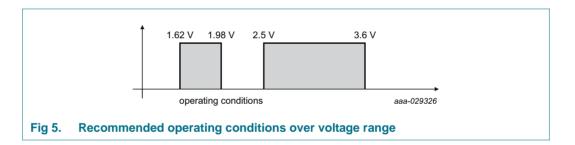
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12. Recommended operating conditions

The A71CL offers two operation modes, the so-called 1V8 mode and the 3V3 mode targeted for battery supplied applications.

Table 8. Recommended operating conditions

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V_{DD}	supply voltage range	3V3 mode range CPU in free runing mode	4	2.50	3.3	3.6	V
		1V8 mode		1.62	1.8	1.98	V
VI	DC input voltage on digital I/O pads I2C_SCL, I2C_SDA	3V3 mode	(0		3.6	V
		1V8 mode	(0		3.6	V
VI	DC input voltage on digital input pad RST_N	3V3 mode	(0		3.6	V
		1V8 mode	(0		3.6	V
T _{amb}	Operating ambient temperature	A7101		-25		+85	°C
		A7102		-40		+90	°C



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13. Characteristics

13.1 DC characteristics

Measurement conventions

Testing measurements are performed at the contact pads of the device under test. All voltages are defined with respect to the ground contact pad VSS. All currents flowing into the device are considered positive.

13.1.1 General and I²C I/O interface

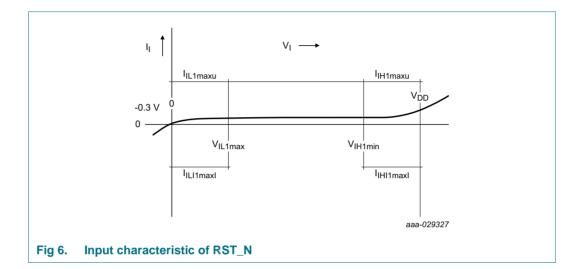
Table 9. Electrical DC characteristics of I2C SCL, I2C SDA and RST N

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Input/Out	put: I2C_SCL, I2C_SDA in push-p	oull mode					
V _{IH}	HIGH level input voltage			$0.7 V_{DD}$		V _{Imax} [1]	V
V _{IL}	LOW level input voltage			-0.5		$0.3 V_{DD}$	V
I _{IH}	HIGH level input current in input mode	$V_{IHmin} < V_{I} < V_{IHmax}$				± 10	μΑ
I _{IL}	LOW level input current	$V_{ILmin} < V_{I} < V_{ILmax}$				± 10	μΑ
V _{OH}	HIGH level output voltage	$I_{OH} = -3.0 \text{ mA};$ 3V3 mode	[2]	0.7 V _{DD}			V
		$I_{OH} = -3.0 \text{ mA};$ 1V8 mode	[2]	0.7 V _{DD}			V
V _{OL} Lo	LOW level output voltage	I _{OL} = 3.0 mA 3V3 mode				0.4	V
Innut/Out	put: I2C_SCL, I2C_SDA in open-c	I _{OL} = 2.0 mA 1V8 mode				0.2 V _{DD}	V
V _{IH}	HIGH level input voltage	iraiii iiiode		0.7 V _{DD}		V _{Imax} [1]	V
V _{IL}	LOW level input voltage			-0.5		0.3 V _{DD}	V
I _{IH}	HIGH level input current in input mode	$V_{IHmin} < V_I < V_{IHmax}$				± 10	μΑ
I _{IL}	LOW level input current	$V_{ILmin} < V_{I} < V_{ILmax}$				± 10	μΑ
V _{OL}	LOW level output voltage	$I_{OL} = 3.0 \text{ mA}$ 3V3 mode				0.4	V
		I _{OL} = 2.0 mA 1V8 mode				0.2 V _{DD}	V
Input: R	ST_N			·	1	1	1
V _{IH1}	HIGH level input voltage			$0.7~V_{DD}$		V _{Imax} [1]	V
V _{IL1}	LOW level input voltage			-0.3		$0.3 V_{DD}$	V
I _{IH1}	HIGH level RST_N input current	$V_{IH1min} \leq V_I \leq V_{DD}$	[3]			± 20	μΑ
-1111							

^[1] Maximum value according to Table 8 "Recommended operating conditions"

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- [2] : External pull-up resistor 20 k Ω to VDD. The worst case test condition for parameter V_{OH} is present at minimum V_{DD}. For class A supply voltage conditions V_{DD} = 4.5 V is the worst case with respect to the fix specification limit V_{OHmin} = 3.8 V (0.844 V_{DD}). The supply voltage related limit "0.7 V_{DD}" is a stricter requirement than the fix value 3.8 V at high V_{DD} (0.7 V_{DD} = 3.85 V at V_{DD} = 5.5 V). So, in the V_{DD} range 4.5 V to 5.5 V, V_{OHmin} is specified as "the larger value of 0.7 V_{DD} and 3.8 V, respectively".
- [3] The active low RST_N input internally has a resistive pull-down device to VSS. Accordingly a current is flowing into the pad voltages above 0 V. Figure 6 shows the RST_N input characteristic.



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13.1.2 I²C interface at 3V3 mode operation[1]

Table 10. Electrical characteristics of IC supply voltage V_{DD} ; $V_{SS} = 0$ V; $T_{amb} = -40$ to +90 °C

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply			'	'	'	'
V_{DD}	supply voltage range	3V3 mode range CPU in free running mode	2.50	3.3	3.6	V
I _{DD}	no coprocessor active	CPU in free running mode		6.3	7.0	mA
	EPROM programming in progress	CPU in free running mode		7.3	8.0	mA
	AES coprocessor active	CPU in free running mode		9.3	10.3	mA
	ECC coprocessor active	CPU in free running mode		13.7	15.1	mA
I _{DD(SLP)}	supply current SLEEP mode	T _{amb} = 25 °C		45	150	μΑ
I _{DD(DSLP)}	supply current deep sleep mode	RST_N at 0V, $T_{amb} = 25 ^{\circ}\text{C}$			10	μΑ
		RST_N at 0V, $T_{amb} = 90 ^{\circ}\text{C}$			10	μΑ

^[1] All appropriately marked values are typical values and only referenced for information. They are subject to change without notice.

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13.1.3 I²C interface at 1V8 mode operation[1]

Table 11. Electrical characteristics of IC supply voltage V_{DD} ; $V_{SS} = 0$ V; $T_{amb} = -40$ to +90 °C

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
Supply				'		
V_{DD}	supply voltage range	1V8 mode range	1.62	1.8	1.98	V
I _{DD}	no coprocessor active	CPU in free running mode		2.45		mA
	AES coprocessor active	CPU in free running mode		2.7		mA
	ECC coprocessor active	CPU in free running mode		7.5		mA
I _{DD(SLP)}	supply current SLEEP mode	T _{amb} = 25 °C		40	80	μΑ
I _{DD(DSLP)}	supply current deep sleep mode	RST_N at 0V, $T_{amb} = 25 ^{\circ}\text{C}$			10	μΑ
		RST_N at 0V, $T_{amb} = 90 ^{\circ}\text{C}$			10	μΑ

^[1] All appropriately marked values are typical values and only referenced for information. They are subject to change without notice.

13.2 AC characteristics

Table 12. Non-volatile memory timing characteristics; V_{DD} = 1.8 V \pm 10% or 3 V \pm 10% V; V_{SS} = 0 V; T_{amb} = -40 to 90 °C

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t_{EEP}	EEPROM erase + program time			2.7		ms
t _{EEE}	EEPROM erase time			1.7		ms
$t_{\sf EEW}$	EEPROM program time			1.0		ms
t _{EER}	EEPROM data retention time	T _{amb} = +55 °C	25			years
N _{EEC}	EEPROM endurance (number of programming cycles)		5 × 10 ⁵			cycles

Table 13. Electrical AC characteristics of I2C_SDA, I2C_SCL, and RST_N[1]; $V_{DD}=1.8~V\pm10\%~or~3~V\pm10\%~V; V_{SS}=0~V; T_{amb}=-40~to~90~^{\circ}C$

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
Input/Ou	itput: I2C_SDA, I2C_SCL in op	en-drain mode	'	'	'	'	'
tr _{IO}	I/O Input rise time	Input/reception mode	<u>[4]</u>			1	μS
tf _{IO}	I/O Input fall time	Input/reception mode	<u>[4]</u>			1	μS
tf _{OIO}	I/O Output fall time	Output/transmission mode; C _L = 30 pF	[4]			0.3	μS
f _{CLK}	External clock frequency in I ² C applications	t_{CLKW} , T_{amb} and V_{DD} in their spec'd limits		-		400	kHz
t _{CLKW}	Clock pulse width i.r.t. clock period (positive pulse duty cycle of CLK)		[3]	40		60	%
Inputs:	RST_N		-				'
t _{RW}	Reset pulse width (RST_N low) without entering deep sleep mode			40		400	μS
t _{RDSLP}	Reset pulse width (RST_N low) to enter deep sleep mode			500			μS
t _{WKP}	Wake-up time from SLEEP mode	$f_{CLKmin} < f_{CLK} < f_{CLKmax}$		-	8	10	μS

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Table 13. Electrical AC characteristics of I2C_SDA, I2C_SCL, and RST_N $^{[1]}$; V_{DD} = 1.8 V \pm 10% or 3 V \pm 10% V; V_{SS} = 0 V; T_{amb} = -40 to 90 °C

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
t _{WKPIO}	Pad LOW time for wake-up from SLEEP mode	level triggered ext.int.	-	8	10	μS
		edge triggered ext.int.	-	8	10	μS
t _{WKPRST}	RST_N LOW time for wake-up from SLEEP mode		40		-	μS
t _{WKWT}	Time from SLEEP mode wake/up event to I2C_SDA valid			50	100	ns
C _{PIN}	Pin capacitances RST_N, I2C_SDA, /I2C_SCL	Test frequency = 1 MHz; T _{amb} = 25 °C	-		10	pF

- [1] All appropriately marked values are typical values and only referenced for information. They are subject to change without notice.
- [2] t_r is defined as rise time between 20% and 80% of the signal amplitude. t_f is defined as fall time between 80% and 20% of the signal amplitude.
- [3] During AC testing the inputs RST_N, I2C_SDA, I2C_SCL are driven at 0 V to +0.3 V for a LOW input level and at V_{DD} -0.3 V to V_{DD} for a HIGH input level. Clock period and signal pulse (duty cycle) timing is measured at 50% of V_{DD}.
- [4] t_r is defined as rise time between 30% and 70% of the signal amplitude. t_f is defined as fall time between 70% and 30% of the signal amplitude.

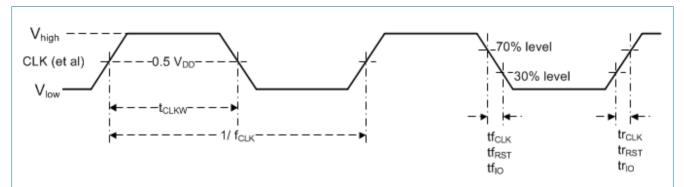


Fig 7. External clock drive and AC test timing reference points of I2C_SDA, I2C_SCL, and RST_N (see <u>Table</u> note [3] and <u>Table note [4]</u>) in open drain mode

13.3 EMC/EMI

EMC and EMI resistance according to IEC 61967-4.

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14. Abbreviations

Table 14. Abbreviations

14510 1 11 715510	
Acronym	Description
AES	Advanced Encryption Standard
CRC	Cyclic Redundancy Check
DES	Digital Encryption Standard
DPA	Differential Power Analysis
DSS	Digital Signature Standard
ECC	Elliptic Curve Cryptography
EEPROM	Electrically Erasable Programmable Read-Only Memory
I/O	Input/Output
MAC	Message Authentication Code
OS	Operating System
PKI	Public Key Infrastructure
SFI	Single Fault Injection
SHA	Secure Hash Algorithm

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15. References

- I²C-bus specification and user manual, Rev. 3.0 June-19-2007, NXP Semiconductors
- [2] SOT909-1; HVSON8; Reel pack; Ordering code (12NC) ending 118; Packing Information; Rev. 2 19 April 2013
- [3] Application note SCIIC Protocol Specification, Application note, Rev 1.5, an195015 31 January 2017
- [4] Application Note A71CL Secure Module Alibaba Cloud Ready APDU Application Note, Rev. 1.1, AN12297

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16. Revision history

Table 15. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
485030	2018-11-27	Short data sheet		
Modifications:	 Table 1 "A710" Section 3.3 "0 Table 3 "A710 Section 5 "Or Figure 2 "A710 Section 6.1 "1 Section 13.1. Section 13.1. Section 13.2. Changed state Title updated Section 1 "Interest of the property of the property	CL block diagram" updated CL commercial name format" updated Cryptography features" updated CL feature table" updated dering information" updated CL functional diagram - exam Functional diagram" updated deferences" updated 2 "I2C interface at 3V3 mode of a "I2C interface at 1V8 mode of	operation[1]" updated operation[1]" updated operation[1]" updated a sheet to Product short	data sheet
485010	2018-07-10	Short data sheet		
Modifications:	 Initial version 			

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17. Legal information

17.1 Data sheet status

Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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18. Contact information

For more information, please visit: http://www.nxp.com

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